

# SL-T4232IRC050-L380

## DATA SHEET

SPEC. NO. : SZ19061802  
DATE : 2019/06/18  
REV. : A/0

Approved By:

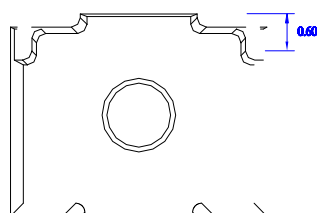
Checked By:

Prepared By:

## Features

Pb free product—RoHS compliant  
 Low power consumption, High efficiency  
 Reliable and rugged  
 Long life – solid state reliability  
 Radiant angle: 20°

## Package Dimension



Part NO.	Chip Material	Lens Color
SL-T4232IRC050-L380	AlGaAs/Si	Water Clear

### Notes:

1. All dimensions are in millimeters.
2. Tolerance is 0.10mm unless otherwise noted
3. Specifications are subject to change without notice.

## Absolute Maximum Ratings at Ta=25

Parameter	MAX.	Unit
Power Dissipation	150	mW
Continuous Forward Current	100	mA
Peak Forward Current <sup>*3</sup>	1.0	A
Reverse Voltage	5	V
Electrostatic Discharge (HBM) <sup>*5</sup>	2000	V
Moisture Sensitivity Level <sup>*1</sup>	5a	
Operating Temperature	-40℃ to + 85℃	
Storage Temperature	-40℃ to + 100℃	
IR Reflow Temperature <sup>*4</sup>	260℃ for 10 Seconds MAX.	

### 1. Storage:

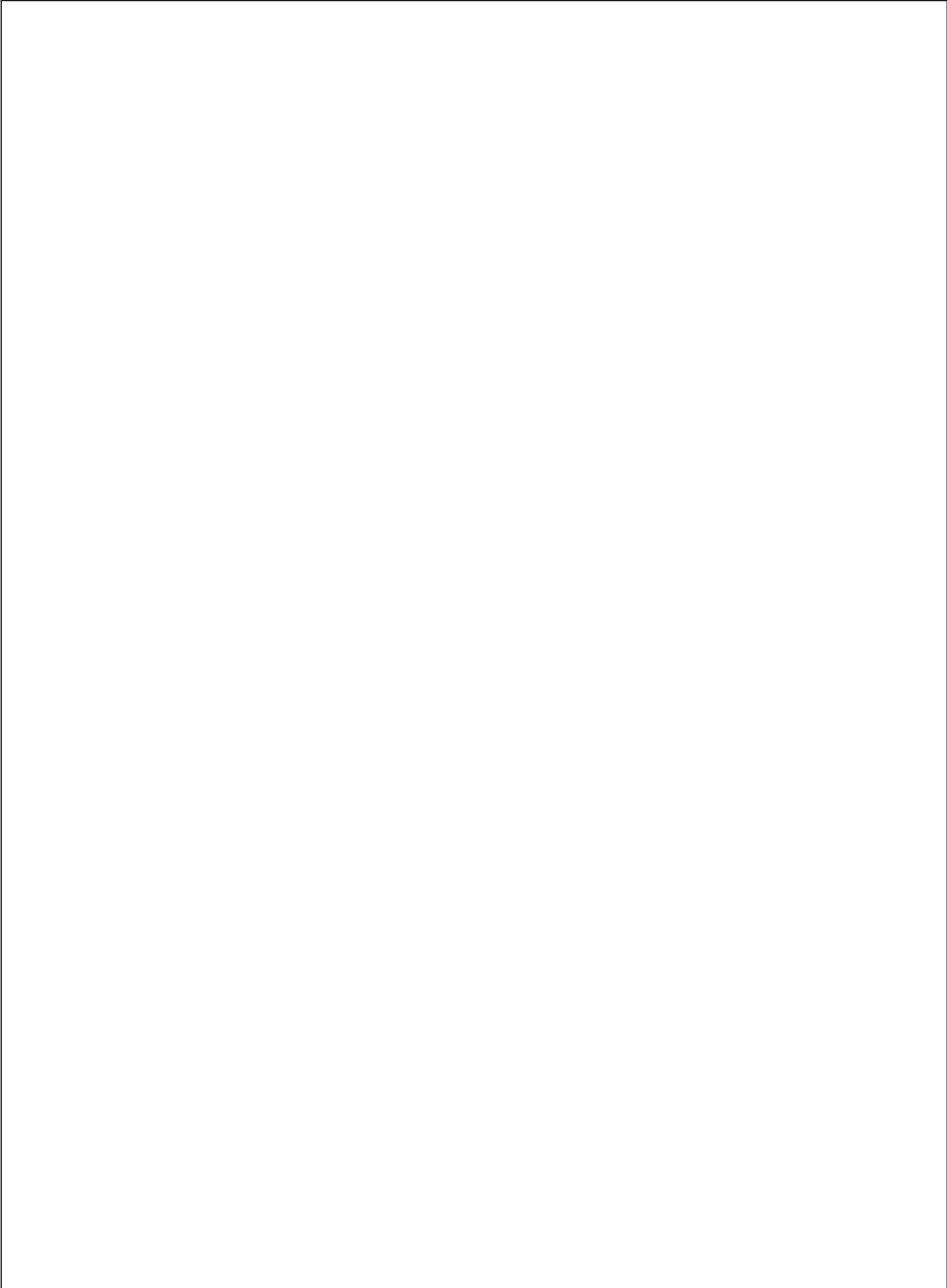
- (1). Storage requirements before vacuum bag opened: Temperature<30℃, Humidity<65%RH;
- (2). Check air leakage and vacuum bag damage before opened. If there is any issue found, check the humidity indicator card immediately after bag opened:
  - a. If color changes on “10% circle” of the humidity indicator card only and not the circles of 20% and above, components can be used without additional handling;
  - b. If color changes on both 10% and 20% circles but not the circles of 30% and above, components must be dehumidified according to the conditions of bullet (5);
  - c. If color changes on 10%, 20%, and 30% circle or above, the product should be returned to the supplier for high temperature dehumidification;
- (3). After bag opened, manual soldering or reflow process must follow the following requirements:
  - a. Complete soldering / reflow within 24 hours;
  - b. Requirements of working environment: Temperature<30℃, Humidity<60%RH;
- (4). If the working condition is outside (3)a or (3)b requirement, the components must be dehumidified according to the conditions of bullet (5);
- (5). Low temperature dehumidification: temperature 60±5℃, 24 hours;
- (6). Shelf life: 30 days. If it's over 30 days from the production date on the package label, the components must be dehumidified according to the condition of bullet (5). If customer is unable to dehumidify, return components to LIGHT for dehumidification.

### 2.




LG-QR-R009-01



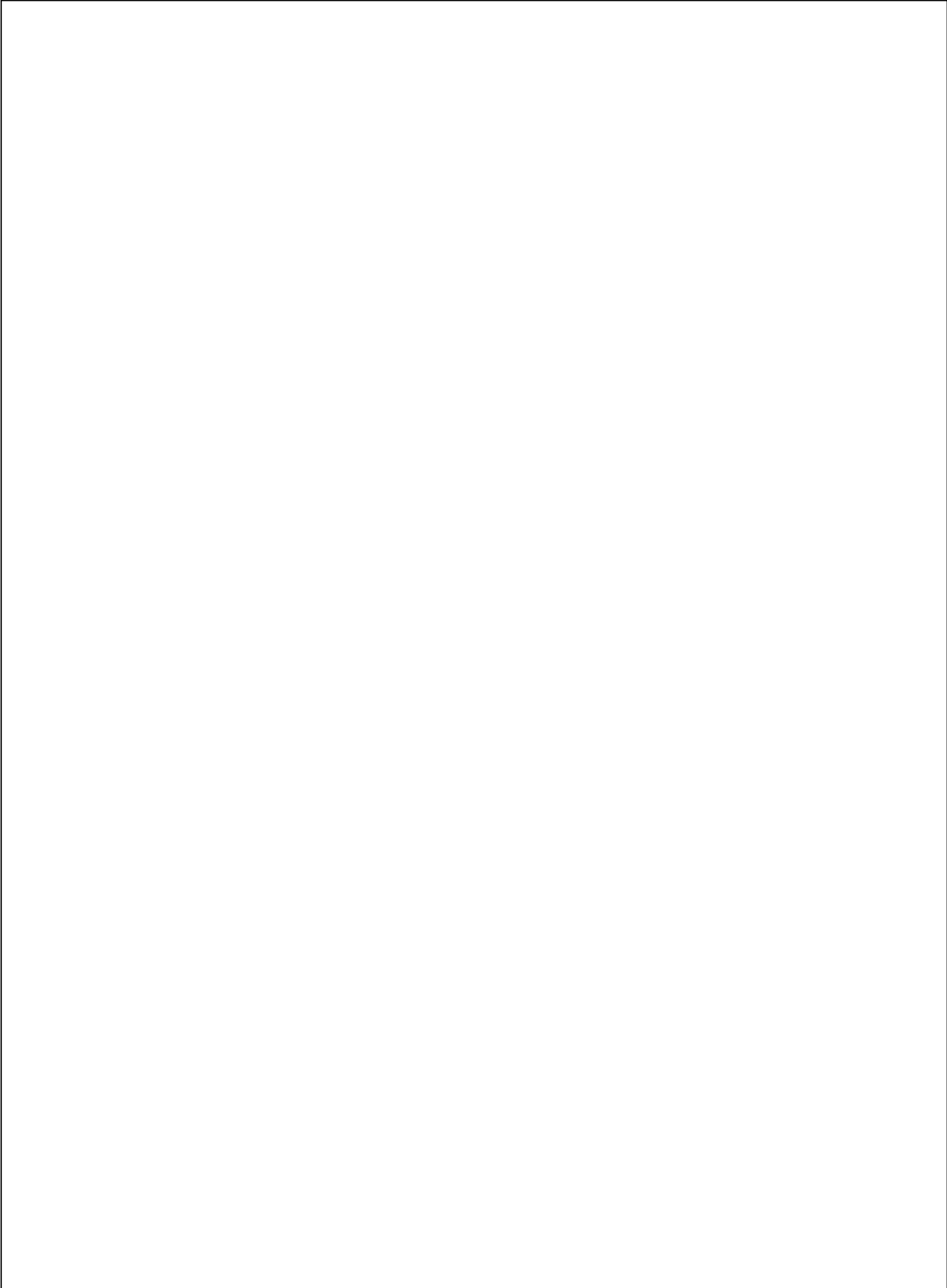


## LIGHT Universal Label

<h1 style="color: blue; margin: 0;">LIGHT</h1> <p style="text-align: center; margin: 0;">Light Electronics CO., LTD.</p>		
MODEL NAME: _____		
QUANTITY: _____		
BIN: _____		
PACKING DATE: _____		
REMARKS: _____		

## Customer Defined Label

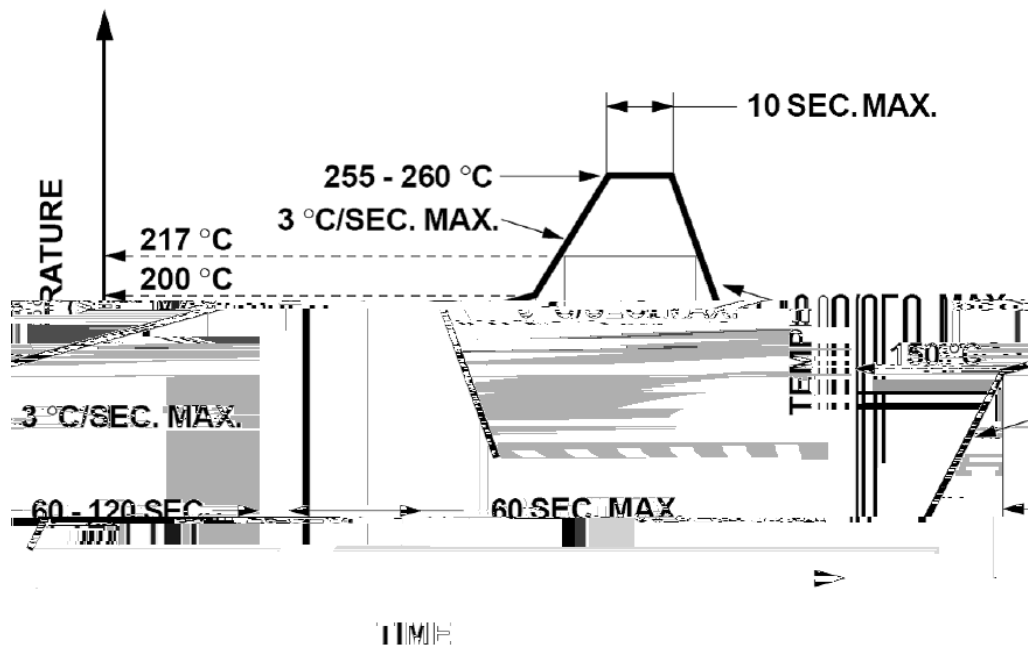
# LIGHT



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## Suggest IR Reflow Condition For Lead Free



1. Reflow soldering should not be done more than two times.
2. When soldering, do not put stress on the LEDs during heating.

## Soldering iron

1. When hand soldering, the temperature of the iron must less than 300 for 3 seconds.
2. The hand solder should be done only once.

## Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.

